DMA96402

Silicon PNP epitaxial planar type

For digital circuits

DMA56402 in SSMini6 type package

Features

- \bullet Low collector-emitter saturation voltage $V_{CE(\text{sat})}$
- Contributes to miniaturization of sets, reduction of component count.
- Eco-friendly Halogen-free package

Basic Part Number

Dual DRA2124E (Individual)

Packaging

DMA964020R Embossed type (Thermo-compression sealing): 8000 pcs / reel (standard)

Absolute Maximum Ratings $T_a = 25^{\circ}C$

Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	V _{CBO}	-50	V
Collector-emitter voltage (Base open)	V _{CEO}	-50	V
Collector current	I _C	-100	mA
Total power dissipation	P _T	125	mW
Junction temperature	Tj	150	°C
Storage temperature	T _{stg}	-55 to +150	°C

SSMini6-F3-B

Package

Code

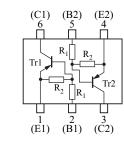
Package dimension clicks here. $\!\!\!\!\rightarrow$

• Pin Name

1: Emitter (Tr1)	4: Emitter (Tr2)

- 2: Base (Tr1)5: Base (Tr2)3: Collector (Tr2)6: Collector (Tr1)
- Marking Symbol: F7

Internal Connection



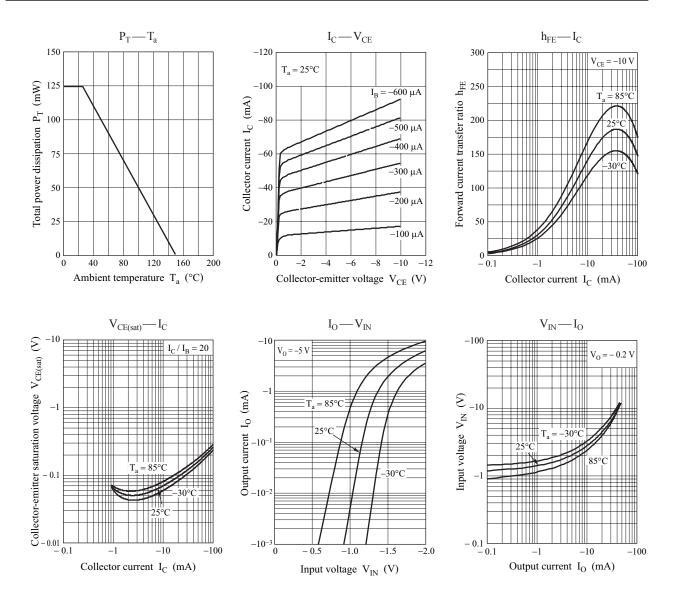
Resistance value	R ₁	22	kΩ
	R ₂	22	kΩ

Conditions Parameter Symbol Min Тур Max Unit -50 V Collector-base voltage (Emitter open) V_{CBO} $I_{\rm C} = -10 \ \mu A$, $I_{\rm E} = 0$ -50V Collector-emitter voltage (Base open) $I_{\rm C} = -2 \, {\rm mA}, I_{\rm B} = 0$ V_{CEO} $V_{CB} = -50 \text{ V}, I_E = 0$ Collector-base cutoff current (Emitter open) -0.1μΑ I_{CBO} Collector-emitter cutoff current (Base open) $V_{CE} = -50 \text{ V}, I_B = 0$ -0.5μΑ I_{CEO} $V_{EB} = -6 V, I_C = 0$ Emitter-base cutoff current (Collector open) -0.2mА I_{EBO} Forward current transfer ratio $V_{CE} = -10 \text{ V}, I_C = -5 \text{ mA}$ 60 h_{FE} $I_{\rm C} = -10 \text{ mA}, I_{\rm B} = -0.5 \text{ mA}$ V Collector-emitter saturation voltage V_{CE(sat)} -0.25Input voltage (ON) $V_{CE} = -0.2 \text{ V}, I_C = -5 \text{ mA}$ -2.6 V V_{I(on)} Input voltage (OFF) $V_{I(off)}$ $V_{CE} = -5 \text{ V}, I_C = -100 \text{ }\mu\text{A}$ -0.8V Input resistance -30% 22 +30% kΩ R_1 Resistance ratio R_1 / R_2 0.8 1.0 1.2 ____

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

DMA96402

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